

Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D $T_C = +25^\circ C$
-40V	45mΩ @ $V_{GS} = -10V$	-20A
	55mΩ @ $V_{GS} = -4.5V$	-18A

Description

This MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- DC-DC Converters
- Power Management Functions

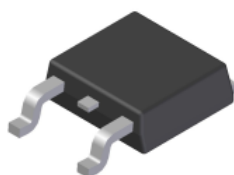
Features

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-resistance
- Fast Switching Speed
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

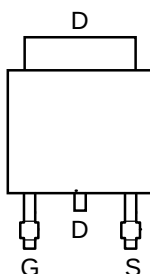
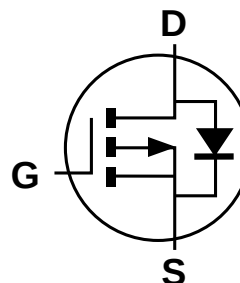
Mechanical Data

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.33 grams (Approximate)

TO252



Top View


 Top View
Pin-Out


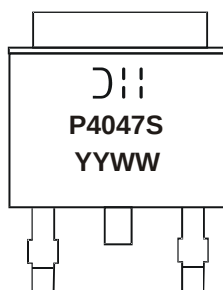
Equivalent Circuit

Ordering Information (Note 4)

Product	Case	Packaging
DMP4047SK3-13	TO252	2,500/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



⏏ = Manufacturer's Marking
 P4047S = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 15 = 2015)
 WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-40	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _C = +25°C T _C = +100°C	I _D	-20 -12.7	A
Maximum Body Diode Continuous Current			I _S	-2.5	A
Pulsed Drain Current (10μs pulse, Duty Cycle = 1%)			I _{DM}	-40	A
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	-18	A
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	16	mJ

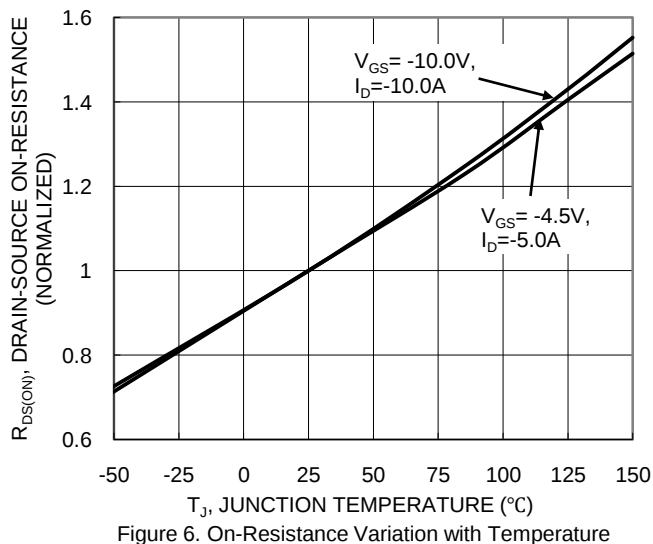
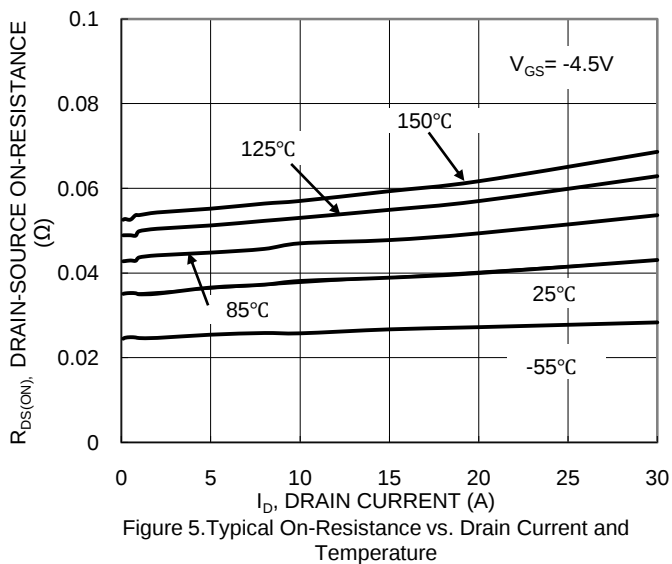
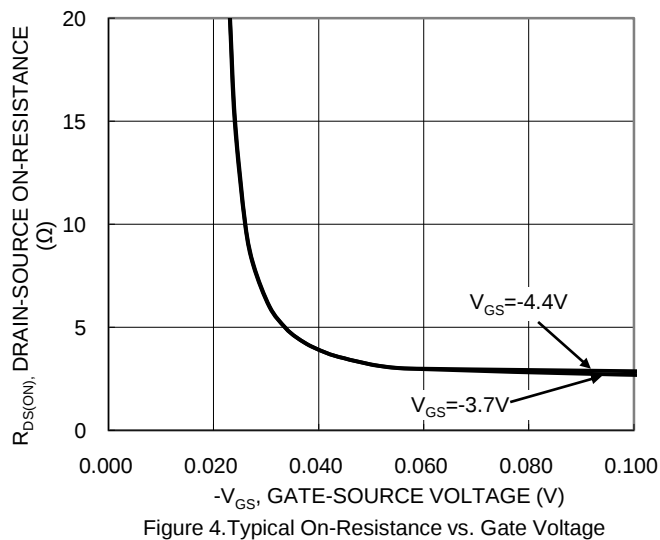
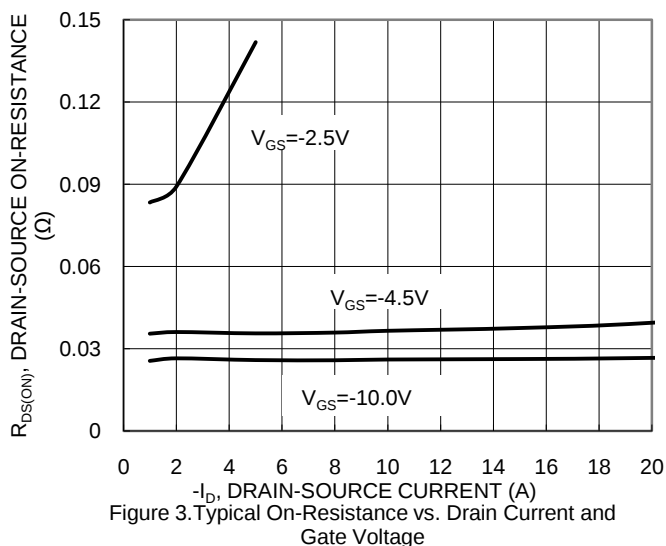
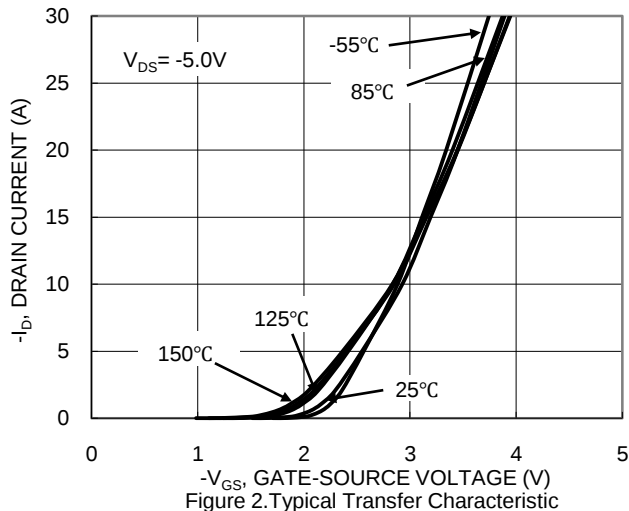
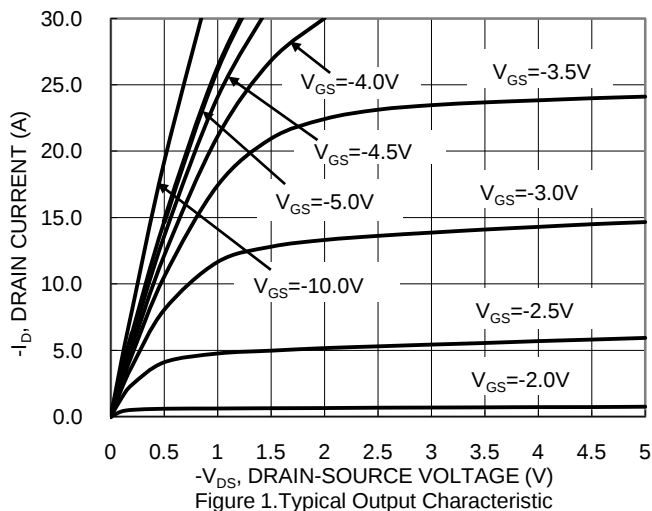
Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

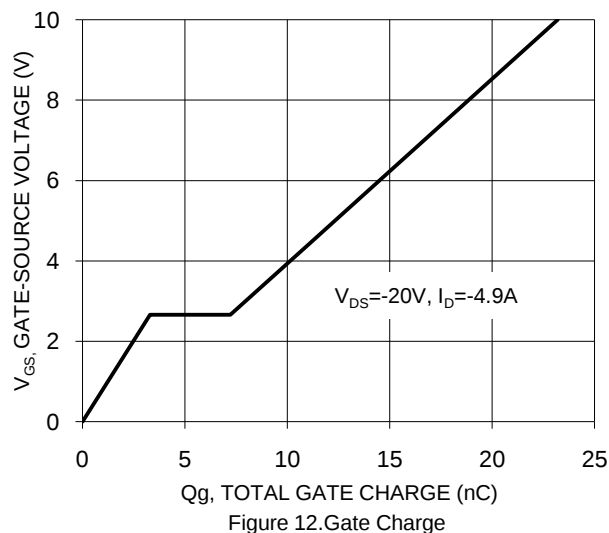
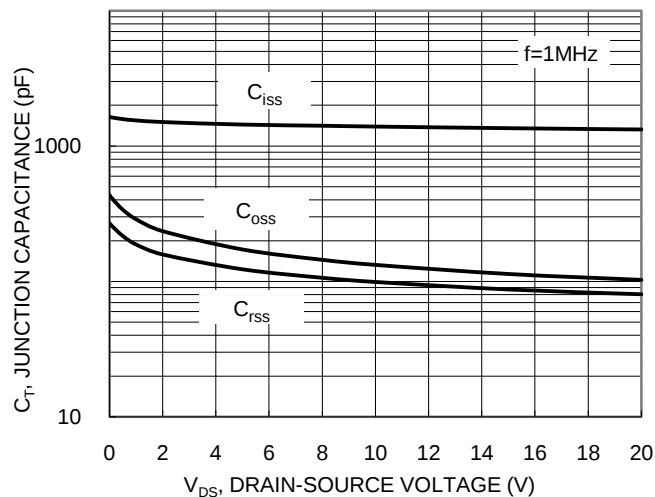
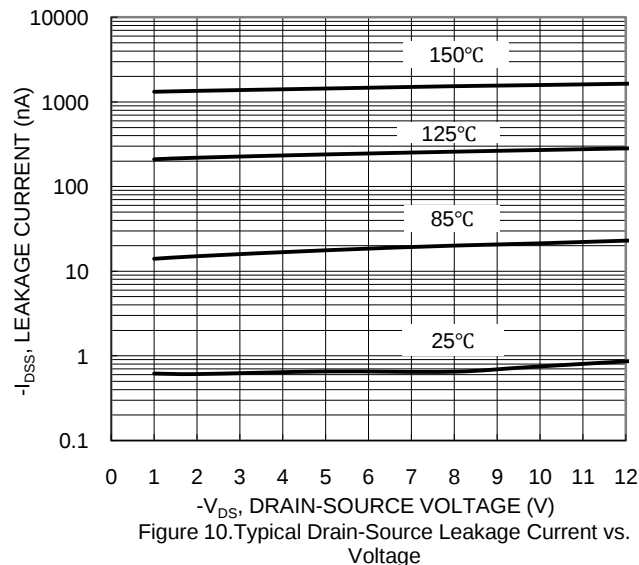
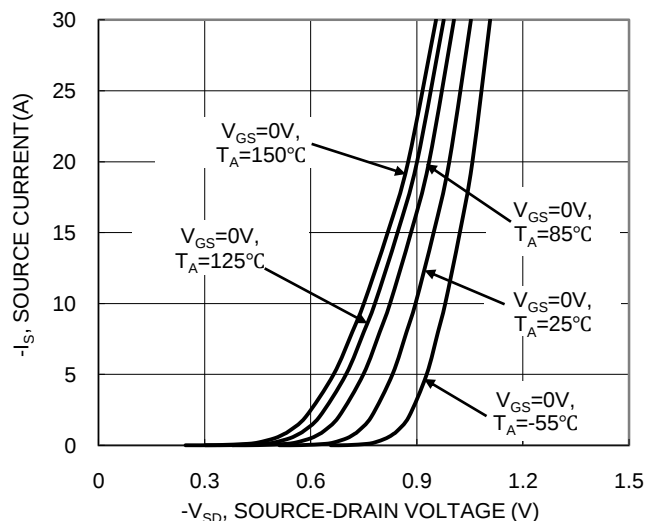
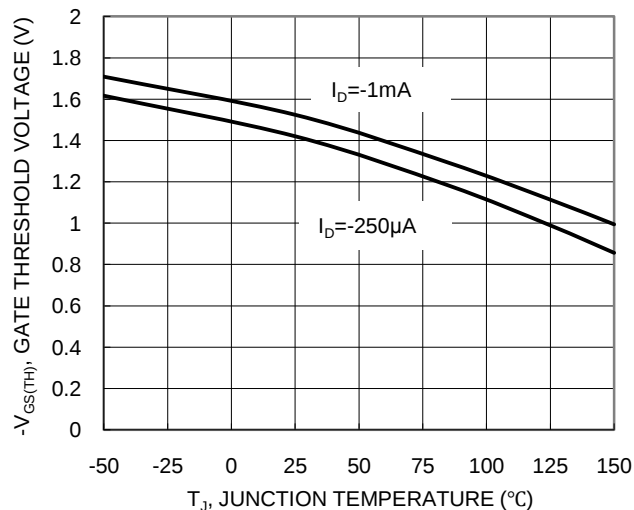
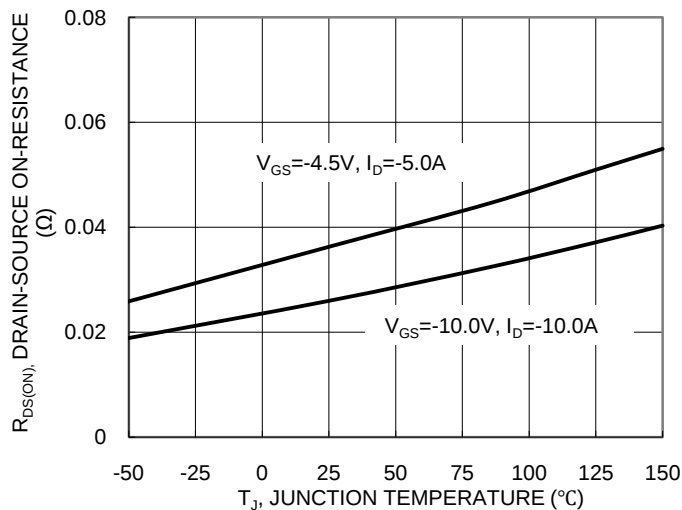
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	1.6	W
	T _A = +70°C		1.0	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	R _{θJA}	77	°C/W
	t < 10s		34	
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.7	W
	T _A = +70°C		1.7	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	R _{θJA}	47	°C/W
	t < 10s		30	
Thermal Resistance, Junction to Case (Note 6)		R _{θJC}	4.8	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	

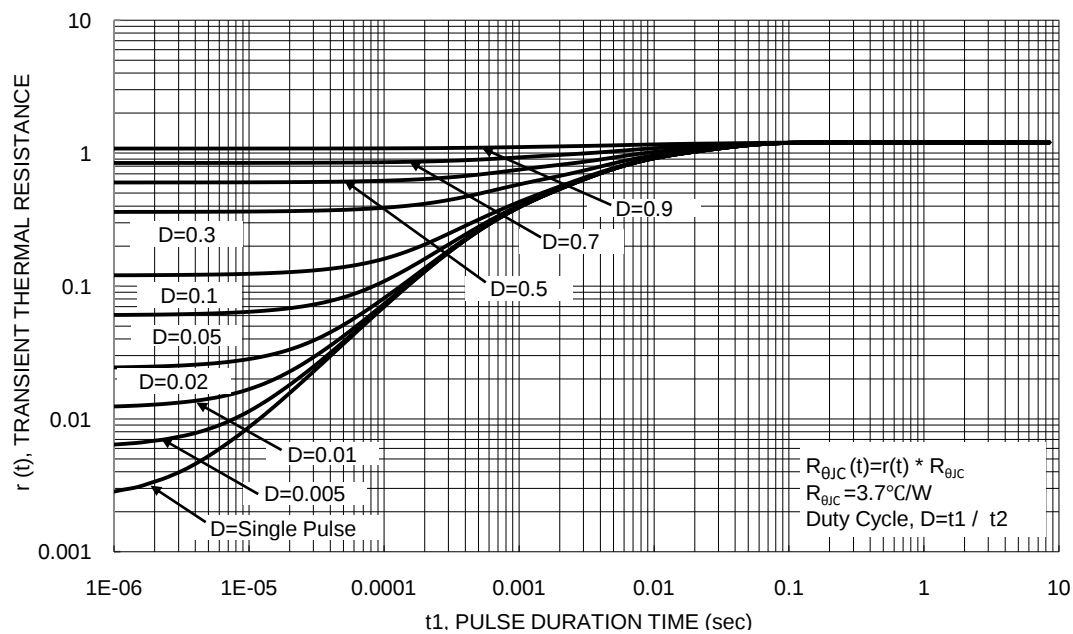
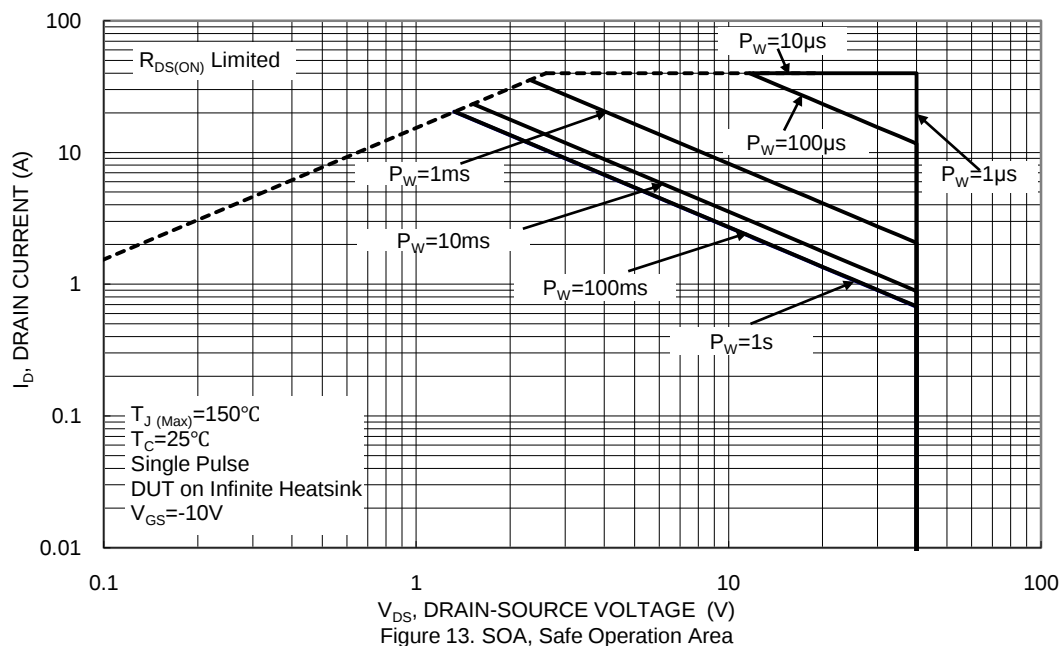
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-40	–	–	V	V _{GS} = 0V, I _D = -250μA
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	–	–	-1	μA	V _{DS} = -40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	–	–	±100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-1.0	–	-3.0	V	V _{DS} = V _{GS} , I _D = -250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	–	33	45	mΩ	V _{GS} = -10V, I _D = -4.4A
			40	55		V _{GS} = -4.5V, I _D = -3.7A
Diode Forward Voltage	V _{SD}	–	-0.75	-1.2	V	V _{GS} = 0V, I _S = -3.9A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	–	1328	–	pF	V _{DS} = -20V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	–	103	–	pF	
Reverse Transfer Capacitance	C _{rss}	–	81	–	pF	
Gate Resistance	R _G	–	7.7	–	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = -4.5V)	Q _g	–	11.2	–	nC	V _{DS} = -20V, I _D = -4.9A
Total Gate Charge (V _{GS} = -10V)	Q _g	–	23.2	–	nC	
Gate-Source Charge	Q _{gs}	–	3.3	–	nC	
Gate-Drain Charge	Q _{gd}	–	3.9	–	nC	
Turn-On Delay Time	t _{D(ON)}	–	18.5	–	ns	V _{DS} = -20V, I _D = -3.9A V _{GS} = 4.5V, R _G = 1Ω
Turn-On Rise Time	t _r	–	28.2	–	ns	
Turn-Off Delay Time	t _{D(OFF)}	–	38.8	–	ns	
Turn-Off Fall Time	t _f	–	28.6	–	ns	
Body Diode Reverse Recovery Time	t _{RR}	–	15.4	–	ns	I _F = -3.9A, di/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q _{RR}	–	5.4	–	nC	

- Notes:
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.

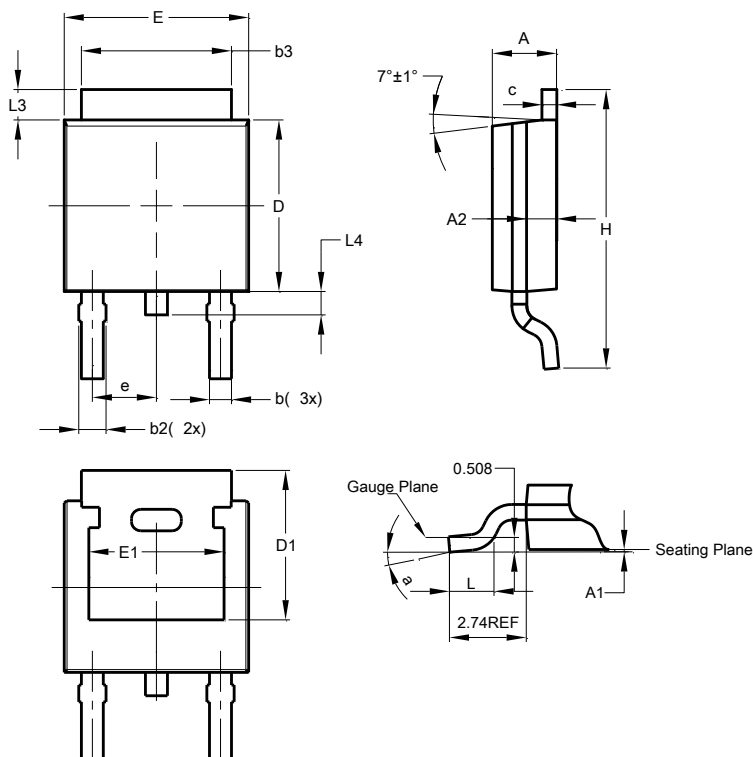






Package Outline Dimensions

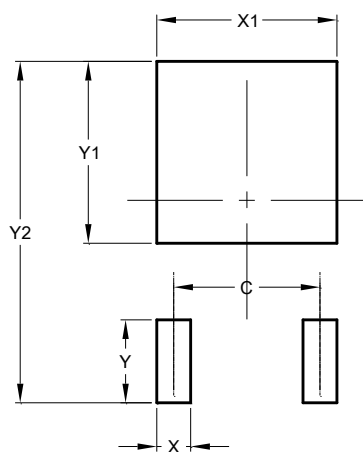
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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